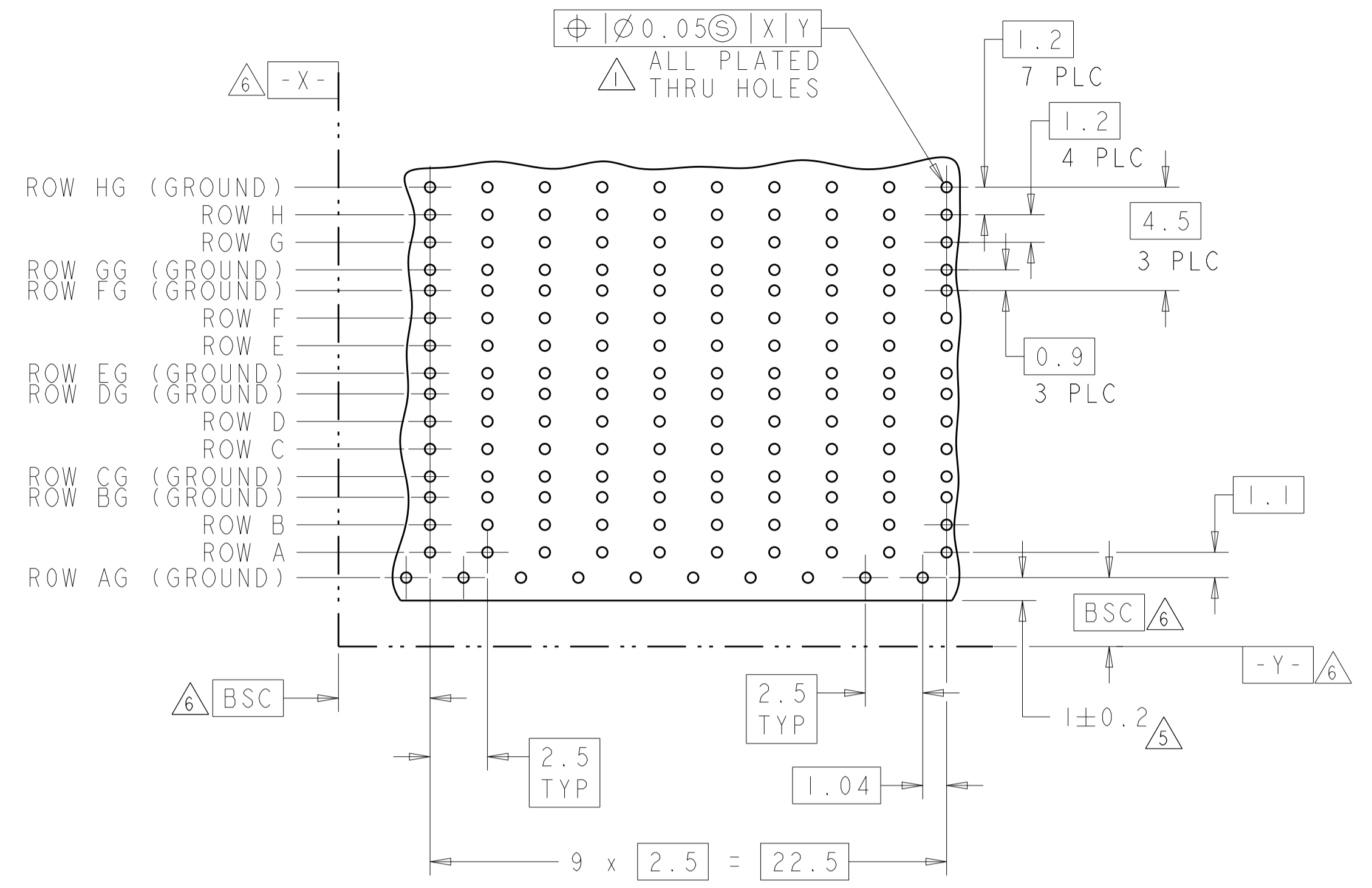
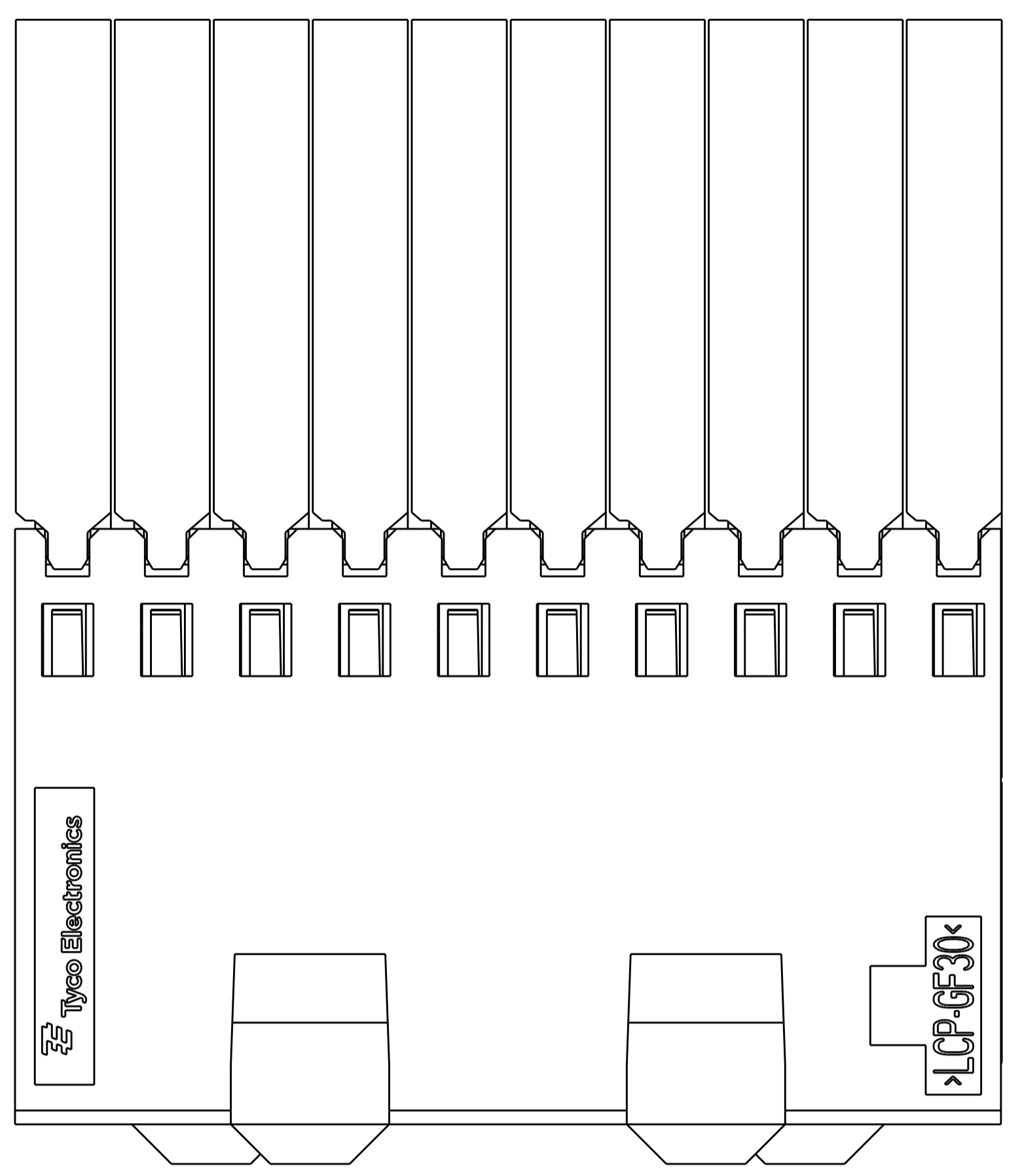
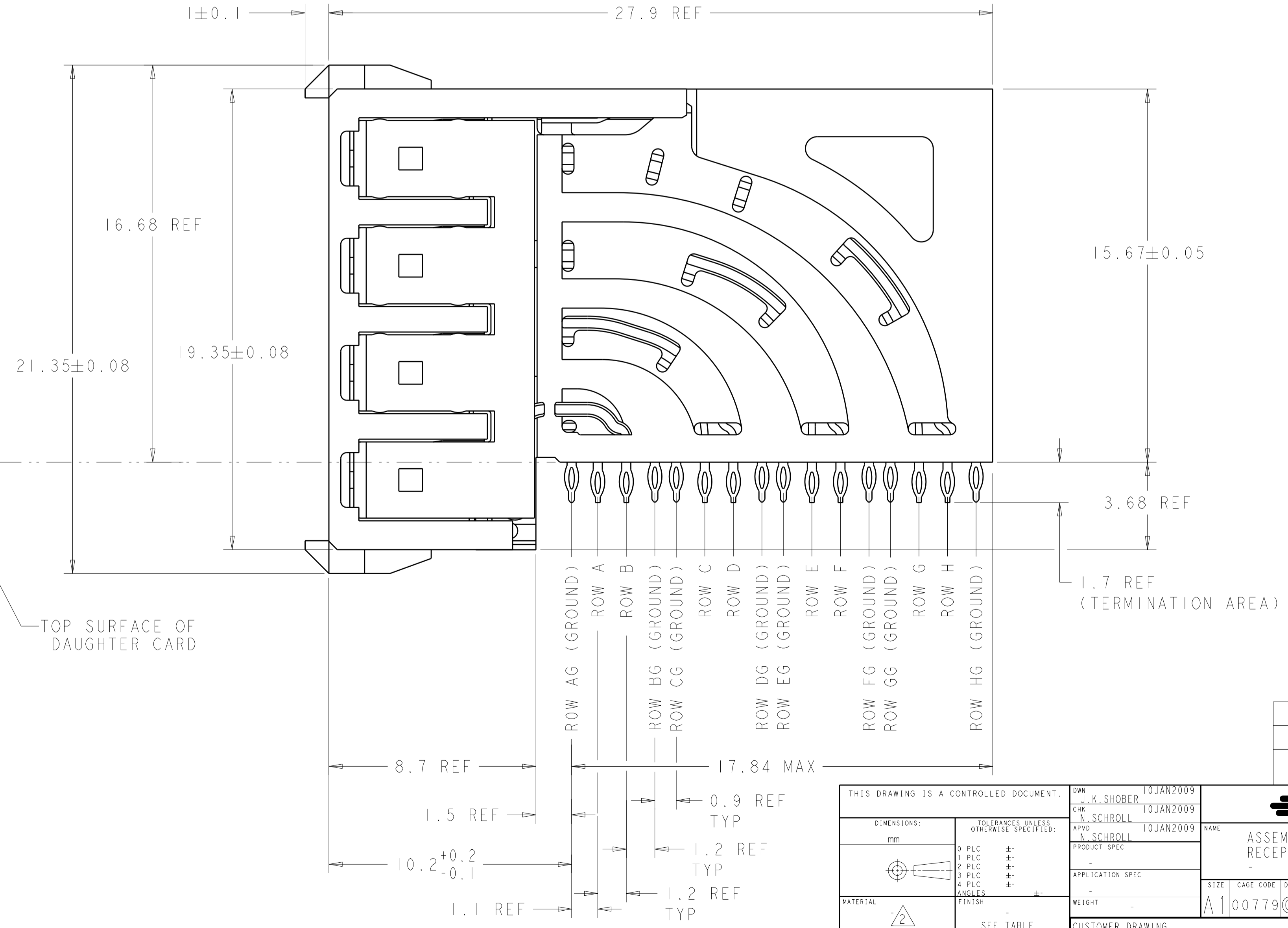
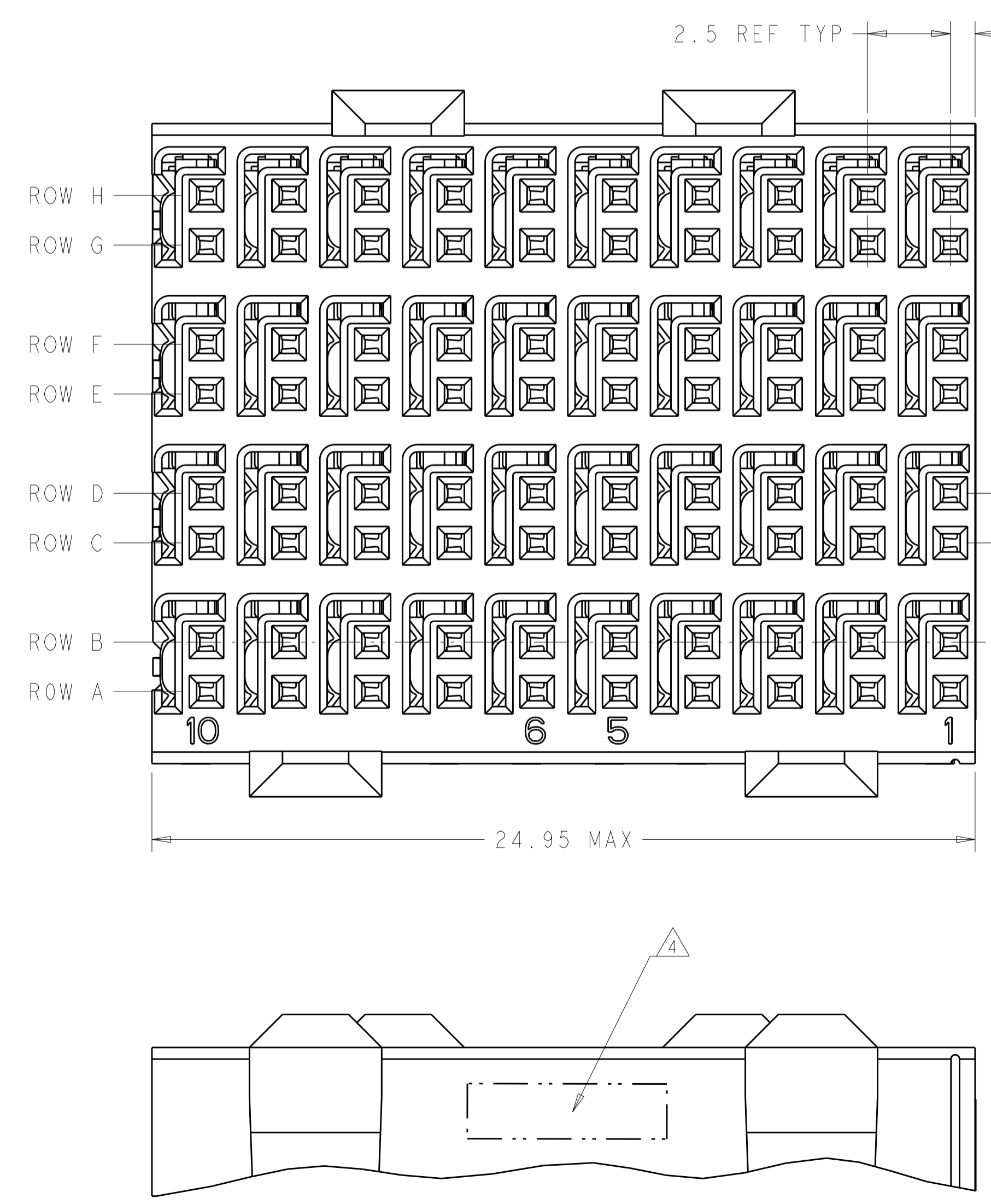


REVISIONS				
P.	LTN.	DESCRIPTION	DATE	APVD.
C		REVISED PER ECO-14-005095	15APR2014	AP RP



RECOMMENDED PC BOARD LAYOUT,
 DAUGHTER BOARD,
 COMPONENT SIDE SHOWN
 SCALE 5:1

- 1. REFERENCE APPLICATION SPEC 114-13059 FOR RECOMMENDED PLATED THRU HOLE DIAMETER AND PLATING THICKNESSES.
- 2. MATERIAL:
 SHIELD - PHOSPHOR BRONZE
 CONTACT - COPPER-NICKEL-SILICON
 HOUSING, CHICKLET AND CHICKLET COVER - GLASS FILLED POLYESTER, UL 94V-0 RATED.
- 3. FINISH: CONTACT AND SHIELD MATING AREA:
 MEETS THE PERFORMANCE REQUIREMENTS OF TYCO ELECTRONICS PRODUCT SPECIFICATION, 108-2055-1; BASED ON TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
 COMPLIANT PIN AREA:
 0.5µm MIN BRIGHT TIN/LEAD OVER BASE PLATING.
- 4. CONNECTOR MARKED WITH PART NUMBER AND DATE CODE IN APPROXIMATE AREA SHOWN.
- 5. DIMENSION APPLIES TO CENTERLINE OF THRU HOLE.
- 6. DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- 7. CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT. TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995.
- 8. FINISH: CONTACT AND SHIELD MATING AREA:
 MEETS THE PERFORMANCE REQUIREMENTS OF TYCO ELECTRONICS PRODUCT SPECIFICATION, 108-2055-1; BASED ON TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
 COMPLIANT PIN AREA:
 0.5µm MIN MATTE TIN OVER BASE PLATING.



3	2065657-2
8	2065657-1
FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS:	TOLERANCES UNLESS OTHERWISE SPECIFIED:	OWN J. K. SHOBER 10JAN2009	CHK N. SCHROLL 10JAN2009	APVD N. SCHROLL 10JAN2009	NAME
mm	0 PLC ±.01	TE Connectivity			ASSEMBLY, Z-Pack Hm-Zd Plus, RECEPTACLE, 4 PAIR
	1 PLC ±.02	A100779C=2065657			
	2 PLC ±.03	RESTRICTED TO			
	3 PLC ±.04	CUSTOMER DRAWING			
	4 PLC ±.05	SCALE 8:1 SHEET 1 OF 1 REV C			
	ANGLES				
MATERIAL	FINISH				
	SEE TABLE				